

Chip beads

For general signal line



MMZ-HE series (for automotive)

AEC-Q200

MMZ1608-HE type



FEATURES

- Noise reduction solution for general signal line.
- The new terminal electrode design improves the bonding strength with solder and supports an environment of 150°C.
- High durability solder can be used.
- Operating temperature range: -55 to +150°C

APPLICATION

- Various ECUs, powertrains and Electric brake booster

PART NUMBER CONSTRUCTION

MMZ	1608	S	HE	102	A	T	D25
Series name	LxWxT dimensions 1.6x0.8x0.8 mm	Material name	Specifications (Grade)	Impedance (Ω) at 100MHz	Characteristic type	Packaging style	Internal code

CHARACTERISTICS SPECIFICATION TABLE

Impedance [100MHz] (Ω)	DC resistance (Ω)max.	Rated current		Part No.	
		125°C (mA)max.	150°C (mA)max.		
120	±25%	0.15	500	300	MMZ1608SHE121ATD25
470	±25%	0.3	500	250	MMZ1608SHE471ATD25
600	±25%	0.35	500	200	MMZ1608SHE601ATD25
1000	±25%	0.5	400	200	MMZ1608SHE102ATD25

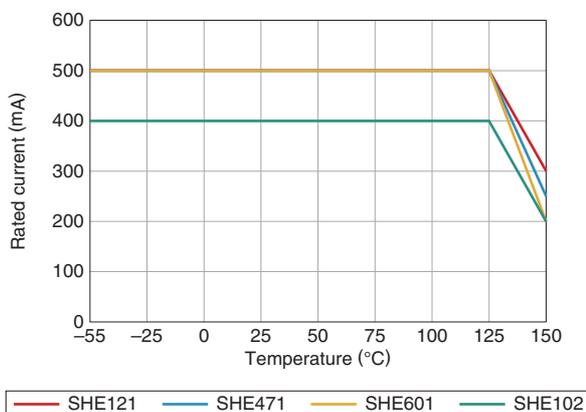
* Please refer to the graph of rated current vs. temperature characteristics (derating) about the rating current at 125°C or more in temperature of the product.

Measurement equipment

Measurement item	Product No.	Manufacturer
Impedance	E4991A+16192A	Keysight Technologies
DC resistance	Type-7556	Yokogawa

* Equivalent measurement equipment may be used.

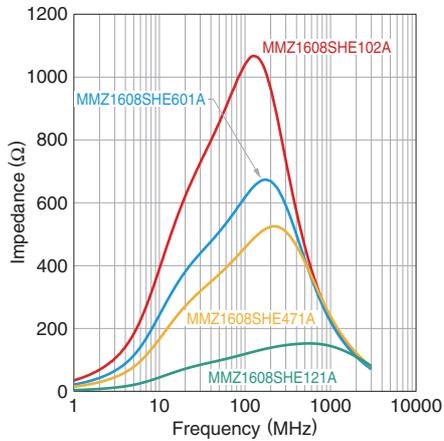
Rated current vs. temperature characteristics (derating)



MMZ1608-HE type

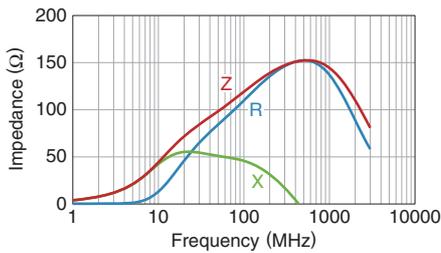
Z VS. FREQUENCY CHARACTERISTICS (BY SERIES)

MMZ1608SHE series

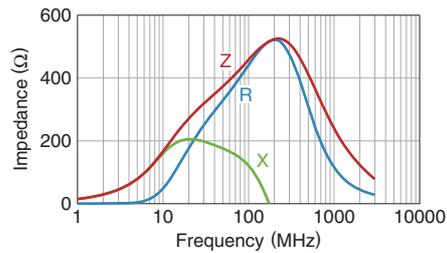


Z, X, R VS. FREQUENCY CHARACTERISTICS

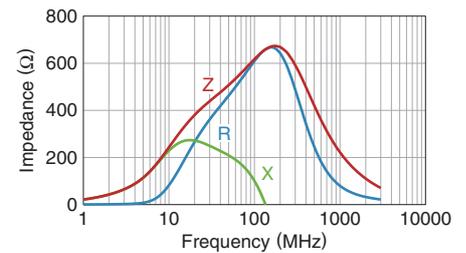
MMZ1608SHE121ATD25



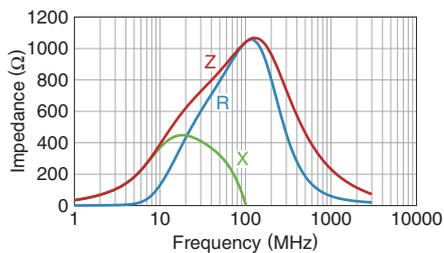
MMZ1608SHE471ATD25



MMZ1608SHE601ATD25



MMZ1608SHE102ATD25



REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products.

REMINDERS

- The storage period is within 12 months. Be sure to follow the storage conditions (temperature: 5 to 40°C, humidity: 10 to 75% RH or less).
If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
- Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
- Before soldering, be sure to preheat components.
The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications.
If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.
- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Carefully lay out the coil for the circuit board design of the non-magnetic shield type.
A malfunction may occur due to magnetic interference.
- Use a wrist band to discharge static electricity in your body through the grounding wire.
- Do not expose the products to magnets or magnetic fields.
- Do not use for a purpose outside of the contents regulated in the delivery specifications.
- The products described in this catalog are intended to be installed in automobiles or automotive electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) and to be used in automobiles (including the case where the said automotive product is mounted in a vehicle) or standard applications as general electronic equipment in automotive applications or standard applications as general electronic equipment in automotive applications in accordance with the scope and conditions described in this specification, while the said automotive or general electronic equipment including the said product is intended to be used in the usual operation and usage methods, respectively. Other than automotive or automotive products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality requires a more stringent level of safety or reliability, or whose failure, malfunction or defect could cause serious damage to society, person or property.

Please understand that we are not responsible for any damage or liability caused by use of the products in any of the applications below or for any other use exceeding the range or conditions set forth in this specification sheet.

If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in this specification, please contact us.

- | | |
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| (1) Aerospace/aviation equipment | (8) Public information-processing equipment |
| (2) Transportation equipment (electric trains, ships, etc.) | (9) Military equipment |
| (3) Medical equipment | (10) Electric heating apparatus, burning equipment |
| (4) Power-generation control equipment | (11) Disaster prevention/crime prevention equipment |
| (5) Atomic energy-related equipment | (12) Safety equipment |
| (6) Seabed equipment | (13) Other applications that are not considered general-purpose applications |
| (7) Transportation control equipment | |

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.